MA22F200G

Silicon epitaxial planar type

For high speed switching circuits

■ Features

- Super high speed switching characteristic ($t_{rr} = 8$ ns typ.)
- At the same time as lowering the wiring inductance and increasing the peak surge forward current, the resistance to surge damage at power on has been increased by adopting clip connection package (TMP).

■ Absolute Maximum Ratings T_a = 25°C

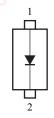
Parameter	Symbol	Rating	Unit	
Repetitive peak reverse voltage	V _{RRM}	200	V	
Non-repetitive peak reverse surge voltage	V _{RSM}	200	V	
Forward current *1	I_{F}	1.0	A	
Non-repetitive peak forward surge current *2	I_{FSM}	15	A	
Junction temperature	T _j	-40 to +150	°C	
Storage temperature	T _{stg}	-40 to +150	°C	

Note) *1: Mounted on an alumina PC board

*2: 50 Hz sine wave 1 cycle (Non-repetitive peak current)

■ Package

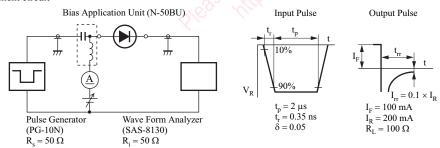
- Code
 - Mini2-F2
- Pin Name
 - 1: Anode
 - 2: Cathode
- Marking Symbol: FB
- Internal Connection



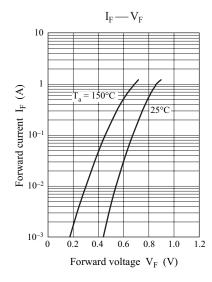
■ Electrical Characteristics $T_a = 25$ °C±3°C

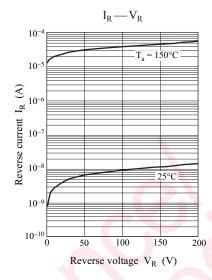
Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Forward voltage	V _F	$I_{\rm F} = 1.0 \rm A$	000	0.85	0.98	V
Reverse current	I_{RRM}	$V_{RRM} = 200 \text{ V}$	1000		20	μΑ
Terminal capacitance	C_{t}	$V_R = 0 \text{ V, } f = 1 \text{ MHz}$	60.	45		pF
Reverse recovery time *	t _{rr}	$I_F = 0.5 \text{ A}, I_R = 1 \text{ A}$ $I_{rr} = 0.25 \text{ A}$		8	35	ns

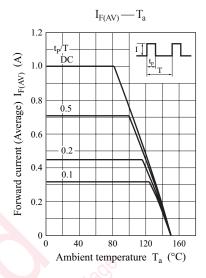
- Note) 1. Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7031 measuring methods for diodes.
 - 2. This product is sensitive to electric shock (static electricity, etc.). Due attention must be paid on the charge of a human body and the leakage of current from the operating equipment.
 - 3. *: t_{rr} measurement circuit

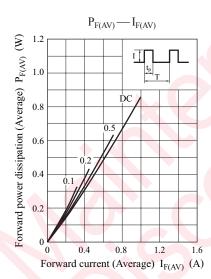


MA22F200G Panasonic





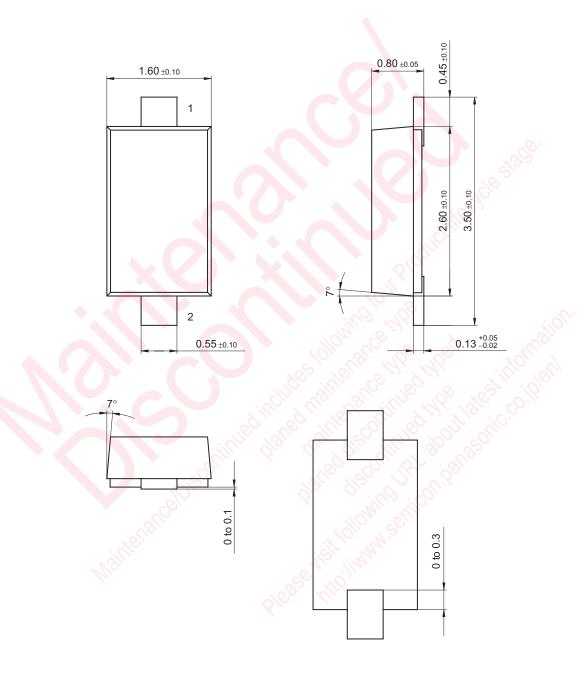




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Panasonic MA22F200G

Mini2-F2 Unit: mm



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